HALOGEN

FREE



Vishay General Semiconductor

SMD Photovoltaic Solar Cell Protection Schottky Rectifier



PRIMARY CHARACTERISTICS			
I _{F(AV)}	15 A		
V_{RRM}	30 V		
I _{FSM}	280 A		
E _{AS}	20 mJ		
V_F at $I_F = 15 A$	0.42 V		
T _J max.	150 °C		

FEATURES

- Very low profile typical height of 1.1 mm
- · Ideal for automated placement
- Guardring for overvoltage protection
- Low forward voltage drop, low power losses
- · High efficiency
- · Low thermal resistance
- Meets MSL level 1, per J-STD-020, LF maximum peak of
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

MECHANICAL DATA

Case: TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

Terminals: Matte tin plated leads, solderable J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

TYPICAL APPLICATIONS

For use in solar cell junction box as a bypass diode for protection, using DC forward current without reverse bias.

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	SS15P3S	UNIT	
Device marking code		153S		
Maximum repetitive peak reverse voltage	V_{RRM}	30	V	
Maximum DC forward current (fig. 1)		15 ⁽¹⁾ 4.5 ⁽²⁾	А	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load		280	А	
Non-repetitive avalanche energy at I _{AS} = 2.0 A, T _J = 25 °C		20	mJ	
Operating junction and storage temperature range		- 55 to + 150	°C	
Junction temperature in DC forward current without reverse bias, t \leq 1 h $^{(3)}$	TJ	≤ 200	°C	

- (1) Mounted on 30 mm x 30 mm Al PCB with 50 mm x 25 mm x 100 mm fin heat sink
- (2) Free air, mounted on recommended copper pad area
- (3) Meets the requirements of IEC 61215 Ed. 2 bypass diode thermal test

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 7.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.43	-	V
	I _F = 15 A			0.50	0.57	
	I _F = 7.5 A	T _A = 125 °C		0.32	-	
	I _F = 15 A			0.42	0.49	
Reverse current	V _R = 30 V	T _A = 25 °C T _A = 125 °C	I _R ⁽²⁾	150	1000	μA
	v _R = 30 v			59	120	mA
Typical junction capacitance	4.0 V, 1 MHz		CJ	930	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	VALUE	UNIT	
Typical thermal resistance	R _{0JA} (1)	100	°C/W	
	R _{0JM} (2)	3	- C/VV	

Notes

- ⁽¹⁾ Free air, mounted on recommended copper pad area. Thermal resistance $R_{\theta JA}$ junction to ambient.
- (2) Mounted on 30 mm x 30 mm Al PCB with 50 mm x 25 mm x 100 mm fin heat sink. Thermal resistance R_{0JM} junction to mount.

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SS15P3S-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel	
SS15P3S-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel	

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

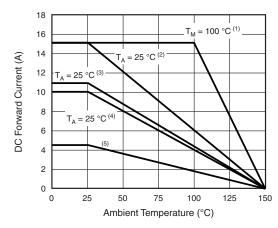


Fig. 1 - Maximum Current Derating Curve

Notes

- $^{(1)}$ Mounted on 30 mm x 30 mm Al PCB with 50 mm x 25 mm x 100 mm fin heat sink, T_M measured at the terminal of cathode
- $^{(2)}$ Mounted on 30 mm x 30 mm Al PCB (R $_{\theta JA}$ = 20 °C/W)
- (3) Mounted on 30 mm x 30 mm x 2 copper pad areas FR4 PCB $(R_{\theta JA} = 30 \text{ °C/W})$
- (4) Mounted on 25 mm x 25 mm x 2 copper pad areas FR4 PCB $(R_{\theta JA} = 30 \, ^{\circ}C/W)$
- (5) Free air, mounted on recommended copper pad area $(R_{\theta JA} = 100 \text{ °C/W})$



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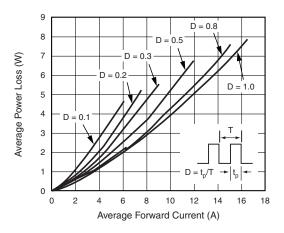


Fig. 2 - Forward Power Loss Characteristics

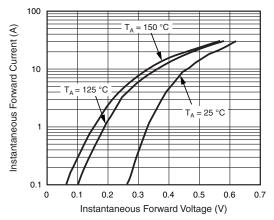


Fig. 3 - Typical Instantaneous Forward Characteristics

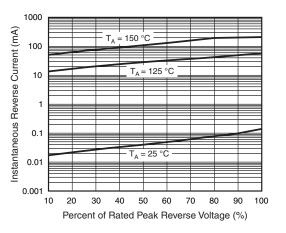


Fig. 4 - Typical Reverse Leakage Characteristics

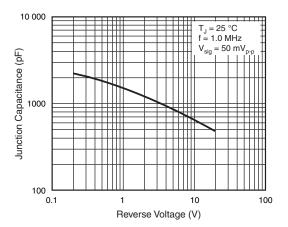


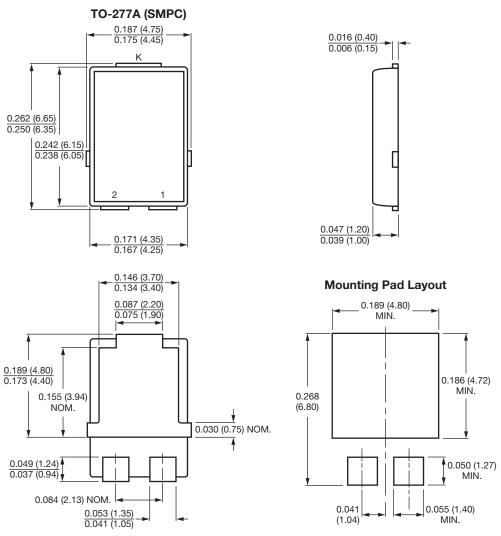
Fig. 5 - Typical Junction Capacitance

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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